ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INFORMATION AND ADDRESS	PC. Bannockt	ourn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration of	on of the su	ubstances s all lower	within the manufacture to the manufacture of the materials for	turer listed which the	l item. Note manufactur	: if the item is an a rer has engineering	ssembly with lowe responsibility.	
			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					erials and	als and Mfg Information				
Supplier Information														
Company name* Company			ny unique ID			Unique ID Authority					Response Date*			
onsemi											2025-05-03			
Contact Name	ntact Name Title - Contact					Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Product Enviro			ro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represe			sentative			Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards Product Env			wiro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item Num		Number Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	2N7002V	2N7002W FET 60V 1.6 mOh		hm SC70		2025-05-03		C	CNF		5.452	mg	Each	
Manufacturing Proccess Informa	tion							·						
Terminal Plating / Grid Array M	aterial T	al Terminal Base Alloy J		J-STD-020 MSL	Rating	Peak Process Bod		ody Temperature Max Time at Peak		ak Tempei	Temperature Number of Reflow Cycles		cles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	sec	onds 3				
omments														
evel 1 - maximum time at peak temperat	ure during sol	ldering is 10-3	0 seconds											
or more information regarding materia	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.231	mg	Supplier	Silicon (Si)	7440-21-3		0.231	mg
Lead Frame	1.294	mg	Supplier	Silver (Ag)	7440-22-4		0.03	mg
			В	Nickel (Ni)	7440-02-0		0.518	mg
			Supplier	Iron (Fe)	7439-89-6		0.746	mg
Mold Compound-Black	3.685	mg		Metal Hydroxide	proprietary data		0.129	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.2948	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0184	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.948	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2948	mg
Plating	0.227	mg	Supplier	Tin (Sn)	7440-31-5		0.227	mg
Wire Bond - Au	0.015	mg	Supplier	Gold (Au)	7440-57-5		0.015	mg